

1 LV2702 TLV2704

FAMILY OF NANOPOWER OPERATIONAL AMPLIFIERS AND PUSH-PULL COMPARATORS

FEATURES

- Micro-Power Operation . . . 1.4 μA
- Input Common-Mode Range Exceeds the Rails ... –0.1 V to V_{CC} + 5 V
- Supply Voltage Range . . . 2.5 V to 16 V
- Rail-to-Rail Input/Output (Amplifier)
- Reverse Battery Protection Up to 18 V
- Gain Bandwidth Product . . . 5.5 kHz (Amplifier)
- Push-Pull CMOS Output Stage (Comparator)
- Specified Temperature Range

 T_A = -40°C to 125°C . . . Industrial Grade
- Ultrasmall Packaging
 8-Pin MSOP (TLV2702)
- Universal Op-Amp EVM (See the SLOU060 For More Information)

APPLICATIONS

- Portable Battery Monitoring
- Consumer Medical Electronics
- Security Detection Systems

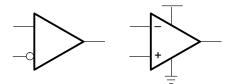
DESCRIPTION

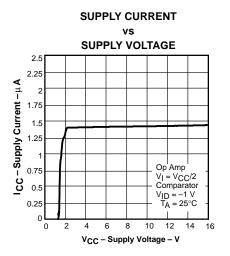
The TLV270x combines sub-micropower operational amplifier and comparator into a single package that produces excellent micropower signal conditioning with only 1.4 μ A of supply current. This combination gives the designer more board space and reduces part counts in systems that require an operational amplifier and comparator. The low supply current makes it an ideal choice for battery powered portable applications where quiescent current is the primary concern. Reverse battery protection guards the amplifier from an over-current condition due to improper battery installation. For harsh environments, the inputs can be taken 5 V above the positive supply rail without damage to the device.

The TLV270x's low supply current is coupled with extremely low input bias currents enabling them to be used with mega-ohm resistors making them ideal for portable, long active life, applications. DC accuracy is ensured with a low typical offset voltage as low as 390μ V, CMRR of 90 dB, and minimum open loop gain of 130 V/mV at 2.7 V.

The maximum recommended supply voltage is as high as 16 V and ensured operation down to 2.5 V, with electrical characteristics specified at 2.7 V, 5 V, and 15 V. The 2.5-V operation makes it compatible with Li-lon battery-powered systems and many micro-power microcontrollers available today including TI's MSP430.

All members are available in PDIP and SOIC with the duals, one op-amp and one comparator, in the small MSOP package and quads, two operational amplifiers and two comparators, in the TSSOP package.







Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



			A SELEC		A SELECTION OF OUTFUT COMPARATORST											
DEVICE	V _{CC} (V)	V _{IO} (μV)	I <u>CC</u> /Ch (μA)	GBW (kHz)	SR (V/μs)	tPLH (μ s)	^t PHL (μs)	^t f (μs)	RAIL-TO- RAIL	OUTPUT STAGE						
TLV270x	2.5 – 16	390	1.4‡	5.5	0.0025	56	83	8	I/O	PP						
TLV230x	2.5 – 16	390	1.4‡	5.5	0.0025	55	30	5	I/O	OD						
TLV240x	2.5 – 16	390	880	5.5	0.0025		—	—	I/O	—						
TLV224x	2.5 – 12	600	1	5.5	0.002		_	_	I/O	_						
TLV340x	2.5 – 16	250	0.47			55	30	5	Ι	OD						
TLV370x	2.5 – 16	250	0.56	_	_	56	83	8		PP						

A SELECTION OF OUTPUT COMPARATORS[†]

[†] All specifications are typical values measured at 5 V.

‡ ICC is specified as one op-amp and one comparator.

TLV2702 AVAILABLE OPTIONS

			PACKAGED D	EVICES	
тд	V _{IO} max		MSC		
'A	AT 25°C	SMALL OUTLINE [†] (D)	MSOP [†] (DGK)	SYMBOLS	PLASTIC DIP (P)
- 40°C to 125°C	4000 μV	TLV2702ID	TLV2702IDGK	xxTIAQF	TLV2702IP

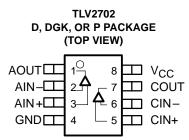
[†] This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLV2702IDR).

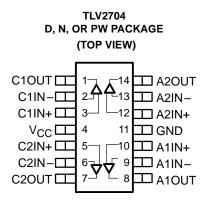
TLV2704 AVAILABLE OPTIONS

		PA	CKAGED DEVICES	
TA	V _{IO} max AT 25°C	SMALL OUTLINE [†] (D)	TSSOP (PW)	PLASTIC DIP (N)
-40°C to 125°C	4000 μV	TLV2704ID	TLV2704IPW	TLV2704IN

[†] This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLV2704IDR).

TLV270x PACKAGE PINOUTS





TLV2702 TLV2704

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC} (see Note 1) Differential input voltage, V _{ID}	V _{CC}
Input voltage range, V _I (see Notes 1 and 2)	00
Input current range, I _I (any input)	±10 mA
Output current range, IO	±10 mA
Continuous total power dissipation	. See Dissipation Rating Table
Continuous total power dissipation Operating free-air temperature range, T _A : I suffix	
	–40°C to 125°C
Operating free-air temperature range, T _A : I suffix	40°C to 125°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential voltages, are with respect to GND

2. Input voltage range is limited to 20 V max or V_{CC} + 5 V, whichever is smaller.

PACKAGE	(°C/W) (°C/		T _A ≤ 25°C POWER RATING	T _A = 125°C POWER RATING						
D (8)	38.3	176	710 mW	142 mW						
D (14)	26.9	122.3	1022 mW	204.4 mW						
DGK (8)	54.2	259.9	481 mW	96.2 mW						
N (14)	32	78	1600 mW	320.5 mW						
P (8)	41	104	1200 mW	240.4 mW						
PW (14)	29.3	173.6	720 mW	144 mW						

DISSIPATION RATING TABLE

recommended operating conditions

			MAX	UNIT
	Single supply	2.5	16	N
Supply voltage, V _{CC}	Split supply	±1.25	±8	V
Common-mode input voltage range, VICR	Amplifier and comparator	-0.1	V _{CC} +5	V
Operating free-air temperature, TA		-40	125	°C



electrical characteristics at recommended operating conditions, V_{CC} = 2.7, 5 V, and 15 V (unless otherwise noted)

amplifier dc performance

	PARAMETER	TEST CONDIT	IONS	т _А †	MIN	TYP	MAX	UNIT
Via	Input offect veltoge			25°C		390	4000	
VIO	Input offset voltage	$V_{O} = V_{CC}/2 V$, $V_{IC} = V_{CC}/2 V$	2 V, R _S = 50 Ω	Full range			6000	μV
ανιο	Offset voltage draft			25°C		3		μV/°C
				25°C	55	73		
			V _{CC} = 2.7 V	Full range	52			
			V _{CC} = 5 V	25°C	60	80		10
CMRR	CMRR Common-mode rejection ratio	V_{IC} = 0 to V_{CC} , R_S = 50 Ω		Full range	55			dB
			V _{CC} = 15 V	25°C	66	90		
				Full range	60			
		$V_{CC} = 2.7 \text{ V}, V_{O(pp)} = 1.5 \text{ V}, R_{L} = 500 \text{ k}\Omega$		25°C	130	400		
				Full range	30			
•	Large-signal differential voltage		D 50010	25°C	300	1000		
A _{VD}	amplification	$V_{CC} = 5 V$, $V_{O(pp)} = 3 V$,	$RL = 500 \text{ k}\Omega$	Full range	100			V/mV
			D 50010	25°C	400	1800		
		$V_{CC} = 15 \text{ V}, V_{O(pp)} = 8 \text{ V},$	$R_{L} = 500 \text{ k}\Omega$	Full range	120			
				25°C	90	120		dB
	Power supply rejection ratio		$V_{CC} = 2.7 \text{ to } 5 \text{ V}$	Full range	85			
PSRR	$(\Delta V_{CC}/\Delta V_{IO})$	$V_{IC} = V_{CC}/2 V$, No load	V _{CC} = 5 to 15 V	25°C	94	120		
				Full range	90			

[†]Full range is -40°C to 125°C.

amplifier and comparator input characteristics

	PARAMETER	TEST CONDITIONS	τ _A †	MIN	TYP	MAX	UNIT	
			25°C		25	250		
Iю	IIO Input offset current		0 to 70°C			300	pА	
		$V_{O} = V_{CC}/2 V$, $V_{IC} = V_{CC}/2 V$	Full range			700		
		$R_{S} = 50 \Omega$	25°C		100	500		
IIB	Input bias current		0 to 70°C			550	pА	
	B Input bias current		Full range			1700		
ri(d)	Differential input resistance		25°C		300		MΩ	
C _{i(c)}	Common-mode input capacitance	f = 100 kHz	25°C		3		pF	

[†] Full range is -40° C to 125° C.



electrical characteristics at recommended operating conditions, V_{CC} = 2.7, 5 V, and 15 V (unless otherwise noted) (continued)

amplifier output characteristics

	PARAMETER		TEST CONDITIONS			TYP	MAX	UNIT
				25°C	2.55	2.65		
			V _{CC} = 2.7 V	Full range	2.5			
	$V_{IC} = V_{CC}/2$		25°C	4.85	4.95			
⊻он	V _{OH} High-level output voltage	V _{IC} = V _{CC} /2, I _{OH} = -50 μA	$V_{CC} = 5 V$	Full range	4.8			V
			V _{CC} = 15 V	25°C	14.8	14.95		
				Full range	14.8			
.,		V _{IC} = V _{CC} /2, I _{OL} = 50 μA		25°C		180	260	
VOL	Low-level output voltage			Full range			300	mV
ΙO	Output current	V _O = 0.5 V from rail		25°C		±200		μA
ZO	Closed-loop output impedance	f = 100 Hz,	A _V = 10	25°C		1.2		kΩ

[†]Full range is -40°C to 125°C.

amplifier dynamic performance

	PARAMETER	TEST CONDITION	IS	Τ _Α	MIN TYP	MAX	UNIT
UGBW	Unity gain bandwidth	R _L = 500 kΩ,	C _L = 100 pF	25°C	5.5		kHz
SR	Slew rate at unity gain	$V_{O(pp)} = 0.8 V$, $R_L = 500 k\Omega$,	CL = 100 pF	25°C	2.5		V/ms
φM	Phase margin	D 50010 0 400-5		0500	60°		
	Gain margin	$R_{L} = 500 \text{ k}\Omega,$ $C_{L} = 100 \text{ pF}$		25°C	15		dB
	$ Settling time \qquad \qquad$	$V_{(STEP)PP} = 1 V, C_{L} = 100 pF,$	0.1%	0500	1.84		ms
t _s		V _{CC} = 15 V,	0.1%	25°C	6.1		
	Equivalent input noise	f = 0.1 to 10 Hz	f = 0.1 to 10 Hz				μV _{pp}
Vn	voltage	f = 100 Hz		25°C	25°C 500		nV/√Hz
In	Equivalent input noise current	f = 100 Hz		25°C	8		fA/√Hz

supply current

PARAMETER		TEST CO	T _A †	MIN	TYP	MAX	UNIT	
	Supply ourrent (one on own and one		V_{CC} = 2.7 V or 5 V	25°C		1.4		
	Supply current (one op-amp and one comparator)	$V_{O} = V_{CC}/2$	N 45.V	25°C		1.4	1.9	μA
	oomparatory		V _{CC} = 15 V	Full range			3.7	L .
	Reverse supply current	$V_{CC} = -18 \text{ V}, \text{ V}_{I} = 0$) V, V _O = open	25°C		50		nA

[†] Full range is -40° C to 125° C.



electrical characteristics at recommended operating conditions, V_{CC} = 2.7, 5 V, and 15 V (unless otherwise noted) (continued)

comparator dc performance

	PARAMETER	TEST COND	DITIONS [†]	т _А †	MIN	TYP	MAX	UNIT
N/				25°C		250	5000	
VIO	Input offset voltage	$V_{IC} = V_{CC}/2$, $R_{S} = 50$	Ω (Full range			7000	μV
ανιο	Offset voltage drift			25°C		3		μV/°C
				25°C	55	72		
			V _{CC} = 2.7 V	Full range	50			dB
CMDD	CMRR Common-mode rejection ratio	V_{IC} = 0 to V_{CC} , R _S = 50 Ω	V _{CC} = 5 V	25°C	60	76		
CINKK				Full range	55			
			V	25°C	65	88		
			V _{CC} = 15 V	Full range	60			
AVD	Large-signal differential voltage amplification			25°C		1000		V/mV
				25°C	75	100		
PSRR	Power supply rejection ratio	$V_{IC} = V_{CC}/2 V$,	$V_{CC} = 2.7 \text{ to } 5 \text{ V}$	Full range	70			dB
FORR	$(\Delta V_{CC}/\Delta V_{IO})$	No load		25°C	85	105		uВ
			V _{CC} = 5 to 15 V	Full range	80			

[†] Full range is -40° C to 125° C.

comparator output characteristics

	PARAMETER	TEST CONDITIONS [†]	T _A †	MIN	TYP	MAX	UNIT	
ri(d)	Differential input resistance		25°C		300		MΩ	
V _{ОН}	I Pak Jawa Landard and a star	$V_{IC} = V_{CC}/2$, $I_{OL} = -50 \mu$ A,	25°C	V _{CC} -320				
	High-level output voltage	$V_{ID} = 1 V$	Full range	V _{CC} -450			mV	
V _{OL}		$V_{IC} = V_{CC}/2$, $I_{OL} = 50 \mu$ A,	25°C		80	200	mV	
	Low-level output voltage	$V_{ID} = -1 V$	Full range			300	ΠV	

[†]Full range is -40°C to 125°C.

switching characteristics at recommended operating conditions, V_{CC} = 2.7 V, 5 V, 15 V (unless otherwise noted)

	PARAMETER	TEST CO	ТА	MIN	TYP	MAX	UNIT		
^t (PLH)	Propagation response time, low-to- high-level output		Overdrive = 2 mV			240			
		f = 10 kHz.	Overdrive = 10 mV	25°C		64			
	nighteveroutput	$V_{\text{STFP}} = 100 \text{ mV},$	Overdrive = 50 mV			36		μs	
^t (PHL)	Propagation response time, high-to- low-level output	$C_{L} = 10 \text{ pF},$	Overdrive = 2 mV			167			
		V _{CC} = 2.7 V	Overdrive = 10 mV	25°C		67		l	
			Overdrive = 50 mV			37			
t _r	Rise time	C _L = 10 pF,	V _{CC} = 2.7 V	25°C		7		μs	
t _f	Fall time	C _L = 10 pF,	V _{CC} = 2.7 V	25°C		9		μs	

NOTE: The propagation response time specified is the interval between the input step function and the instant when the output crosses 1.4 V. Propagation responses are longer at higher supply voltages, refer to Figure 18 through Figure 36 for further details.



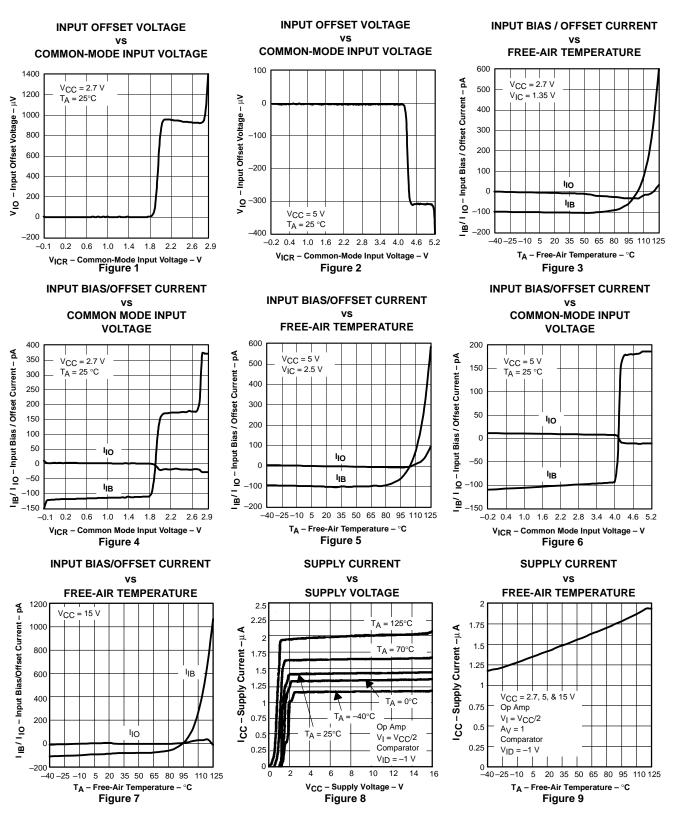
TYPICAL CHARACTERISTICS

Table of Graphs

			FIGURE
VIO	Input offset voltage	vs Common-mode input voltage	1, 2
		vs Free-air temperature	3, 5, 7
IB	Input bias current	vs Common-mode input voltage	4, 6
	land offerst summer	vs Free-air temperature	3, 5, 7
IO	Input offset current	vs Common-mode input voltage	4, 6
	Our also and a	vs Supply voltage	8
ICC	Supply current vs Free-air temperature		9
Amplifier			
CMRR	Common-mode rejection ratio	vs Frequency	10
Vон	High-level output voltage	vs High-level output current	11, 13
VOL	Low-level output voltage	vs Low-level output current	12, 14
VO(PP)	Output voltage, peak-to-peak	vs Frequency	15
PSRR	Power supply rejection ratio	vs Frequency	16
	Voltage noise over a 10 Second Period		17
[¢] m	Phase margin	vs Capacitive load	18
A _{VD}	Differential voltage gain	vs Frequency	19
	Phase	vs Frequency	19
	Gain-bandwidth product	vs Supply voltage	20
SR	Slew rate	vs Free-air temperature	21
	Large-signal follower pulse response		22
	Small-signal follower pulse response		23
	Large-signal inverting pulse response		24
	Small-signal inverting pulse response		25
Comparator			
VOH	High-level output voltage	vs High-level output current	26, 28
VOL	Low-level output voltage	vs Low-level output current	27, 29
	Output rise/fall time	vs Supply voltage	30
	Low-to-high level output response for various input overdrives		31, 33, 35
	High-to-low level output response for various input overdrives		32, 34, 36



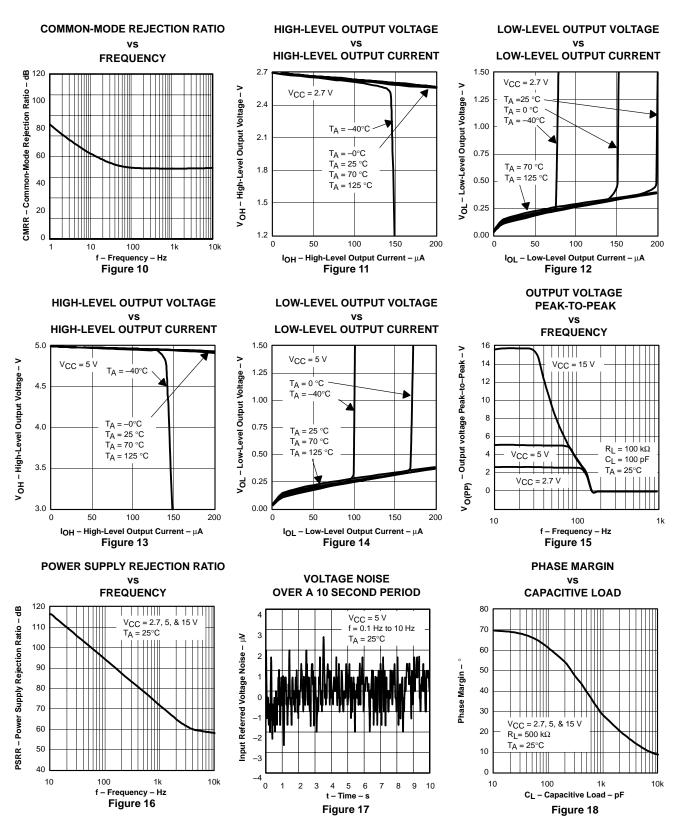
AMPLIFIER AND COMPARATOR TYPICAL CHARACTERISTICS





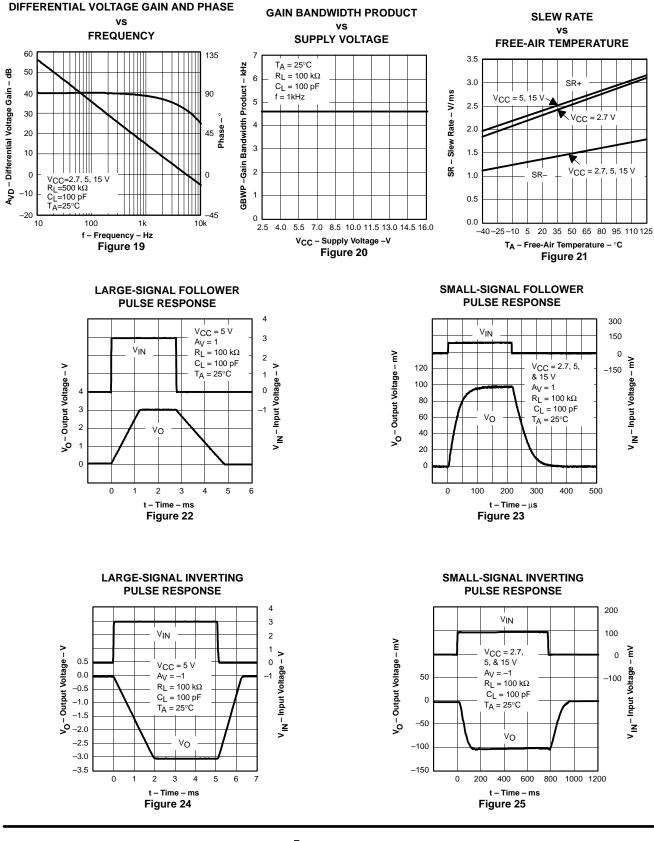
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AMPLIFIER TYPICAL CHARACTERISTICS





AMPLIFIER TYPICAL CHARACTERISTICS

LOW-LEVEL OUTPUT VOLTAGE

vs

HIGH-LEVEL OUTPUT CURRENT LOW-LEVEL OUTPUT CURRENT 2.7 V_{CC} = 2.7 V V_{ID} = -1 V 2.7 $V_{CC} = 2.7 V$ $V_{ID} = -1 V$ V_{OH} – High-Level Output Voltage – V 2.4 > 2.4 Т $T_A = 125^{\circ}C$ 2.1 VoL – Low-Level Output Voltage 2.1 $T_A = -40^{\circ}C$ 1 $T_A = 0^{\circ}C$ $T_A = 70^{\circ}C$ 1.8 1.8 TA = 25°C 1.5 1.5 $T_A = 25^{\circ}C$ 1.2 1.2 $T_A = 0^{\circ}C$ 0.9 0.9 $T_A = 70^{\circ}C$ 0.6 0.6 -40°C TΑ 0.3 0.3 T_A = 125°C 0.0 0.0 0 0.05 0.1 0.15 0.2 0.25 0.3 0.35 0.4 0.45 0 0.1 0.2 0.3 0.4 0.5 0.6 0.7 0.8 IOH - High-Level Output Current - mA IOL – Low-Level Output Current – mA Figure 26 Figure 27 **HIGH-LEVEL OUTPUT VOLTAGE** LOW-LEVEL OUTPUT VOLTAGE vs vs **HIGH-LEVEL OUTPUT CURRENT** LOW-LEVEL OUTPUT CURRENT 5 5 $V_{CC} = 5 V$ $V_{ID} = -1 V$ V_{CC} = 5 V V_{ID} = -1 V V_{OH} – High-Level Output Voltage – V 4.5 4.5 V_{OL} – Low-Level Output Voltage – V ÉL 4 4 T_A = _40°C $T_A = 125^{\circ}C$ 3.5 $T_A = 0^{\circ}C$ 3.5 . T_A = 70°C 3 3 $T_A = 25^{\circ}C$ 2.5 2.5 2 2 $T_A = 25^{\circ}C$ $T_A = 70^{\circ}C$ 1.5 1.5 $T_A = 0^{\circ}C$ T_A = 125°C $T_A = -40^{\circ}C$ 0.5 0.5 0 0 0.2 0.4 0.6 0.8 1.0 1.2 1.4 0 1.6 1.8 0 0.4 0.8 1.2 1.6 2.0 2.4 IOH - High-Level Output Current - mA IOL - Low-Level Output Current - mA Figure 28 Figure 29 **OUTPUT RISE/FALL TIME** vs SUPPLY VOLTAGE 120 V_{ID}= 1 V to -1 V з'n Input Rise/Fall Time $C_L = 10 \text{ pF}$ $T_A = 25^{\circ}\text{C}$ t_{r(f)} – Output Rise/Fall Time – 100 80 60 Fall Time 40

COMPARATOR TYPICAL CHARACTERISTICS

HIGH-LEVEL OUTPUT VOLTAGE

vs



7.5

V_{CC} – Supply Voltage – V Figure 30

5

Rise Time

10 12.5

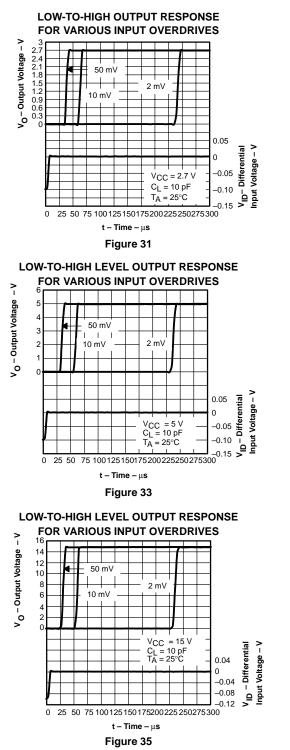
15

20

0 0

2.5

2.8



TYPICAL CHARACTERISTICS

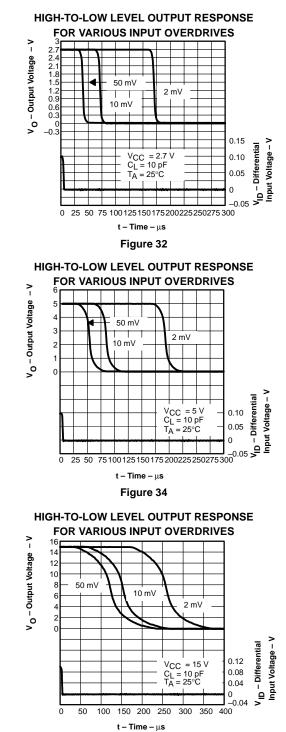


Figure 36



APPLICATION INFORMATION

reverse battery protection

The TLV2702/4 are protected against reverse battery voltage up to 18 V. When subjected to reverse battery condition the supply current is typically less than 100 nA at 25°C (inputs grounded and outputs open). This current is determined by the leakage of 6 Schottky diodes and will therefore increase as the ambient temperature increases.

When subjected to reverse battery conditions and negative voltages applied to the inputs or outputs, the input ESD structure will turn on—this current should be limited to less than 10 mA. If the inputs or outputs are referred to ground, rather than midrail, no extra precautions need be taken.

common-mode input range

The TLV2702/4 has rail-rail input and outputs. For common-mode inputs from -0.1 V to V_{CC} -0.8 V a PNP differential pair will provide the gain.

For inputs between V_{CC} – 0.8 V and V_{CC} , two NPN emitter followers buffering a second PNP differential pair provide the gain. This special combination of NPN/PNP differential pair enables the inputs to be taken 5 V above the rails; because as the inputs go above V_{CC} , the NPNs switch from functioning as transistors to functioning as diodes. This will lead to an increase in input bias current. The second PNP differential pair continues to function normally as the inputs exceed V_{CC} .

The TLV2702/4 has a negative common-input range that exceeds ground by 100 mV. If the inputs are taken much below this, reduced open loop gain will be observed with the ultimate possibility of phase inversion.

offset voltage

The output offset voltage, (V_{OO}) is the sum of the input offset voltage (V_{IO}) and both input bias currents (I_{IB}) times the corresponding gains. The following schematic and formula can be used to calculate the output offset voltage.

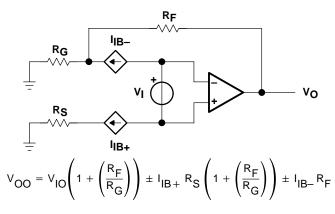


Figure 37. Output Offset Voltage Model



APPLICATION INFORMATION

general configurations

When receiving low-level signals, limiting the bandwidth of the incoming signals into the system is often required. The simplest way to accomplish this is to place an RC filter at the noninverting terminal of the amplifier (see Figure 38).

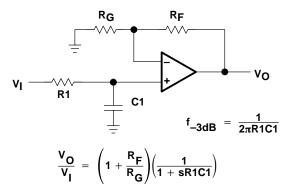


Figure 38. Single-Pole Low-Pass Filter

If even more attenuation is needed, a multiple pole filter is required. The Sallen-Key filter can be used for this task. For best results, the amplifier should have a bandwidth that is 8 to 10 times the filter frequency bandwidth. Failure to do this can result in phase shift of the amplifier.

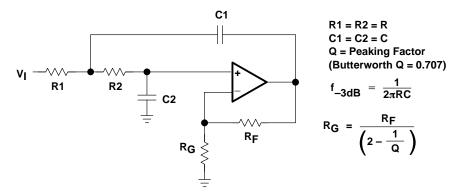


Figure 39. 2-Pole Low-Pass Sallen-Key Filter



APPLICATION INFORMATION

circuit layout considerations

To achieve the levels of high performance of the TLV270x, follow proper printed-circuit board design techniques. A general set of guidelines is given in the following.

- Ground planes—It is highly recommended that a ground plane be used on the board to provide all components with a low inductive ground connection. However, in the areas of the amplifier inputs and output, the ground plane can be removed to minimize the stray capacitance.
- Proper power supply decoupling—Use a 6.8-µF tantalum capacitor in parallel with a 0.1-µF ceramic capacitor on each supply terminal. It may be possible to share the tantalum among several amplifiers depending on the application, but a 0.1-µF ceramic capacitor should always be used on the supply terminal of every amplifier. In addition, the 0.1-µF capacitor should be placed as close as possible to the supply terminal. As this distance increases, the inductance in the connecting trace makes the capacitor less effective. The designer should strive for distances of less than 0.1 inches between the device power terminals and the ceramic capacitors.
- Sockets—Sockets can be used but are not recommended. The additional lead inductance in the socket pins
 will often lead to stability problems. Surface-mount packages soldered directly to the printed-circuit board
 is the best implementation.
- Short trace runs/compact part placements—Optimum high performance is achieved when stray series inductance has been minimized. To realize this, the circuit layout should be made as compact as possible, thereby minimizing the length of all trace runs. Particular attention should be paid to the inverting input of the amplifier. Its length should be kept as short as possible. This will help to minimize stray capacitance at the input of the amplifier.
- Surface-mount passive components—Using surface-mount passive components is recommended for high
 performance amplifier circuits for several reasons. First, because of the extremely low lead inductance of
 surface-mount components, the problem with stray series inductance is greatly reduced. Second, the small
 size of surface-mount components naturally leads to a more compact layout thereby minimizing both stray
 inductance and capacitance. If leaded components are used, it is recommended that the lead lengths be
 kept as short as possible.



general power dissipation considerations

For a given θ_{JA} , the maximum power dissipation is shown in Figure 40 and is calculated by the following formula:

$$\mathsf{P}_{\mathsf{D}} = \left(\frac{\mathsf{T}_{\mathsf{MAX}} - \mathsf{T}_{\mathsf{A}}}{\theta_{\mathsf{JA}}}\right)$$

Where:

P_D = Maximum power dissipation of TLV270x IC (watts)

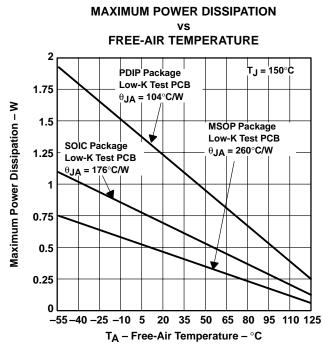
 T_{MAX} = Absolute maximum junction temperature (150°C)

 T_A = Free-ambient air temperature (°C)

$$\theta_{JA} = \theta_{JC} + \theta_{CA}$$

 $\theta_{\rm JC}$ = Thermal coefficient from junction to case

 θ_{CA} = Thermal coefficient from case to ambient air (°C/W)



NOTE A: Results are with no air flow and using JEDEC Standard Low-K test PCB.



TLV2702 TLV2704

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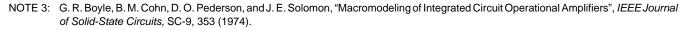
APPLICATION INFORMATION

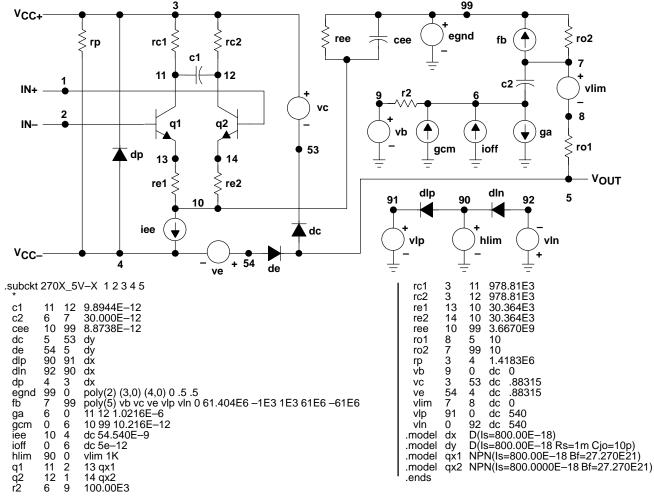
amplifier macromodel information

Macromodel information provided was derived using Microsim *Parts*TM Release 8, the model generation software used with Microsim *PSpice*TM. The Boyle macromodel (see Note 2) and subcircuit in Figure 41 are generated using the TLV270x typical electrical and operating characteristics at $T_A = 25^{\circ}$ C. Using this information, output simulations of the following key parameters can be generated to a tolerance of 20% (in most cases):

- Maximum positive output voltage swing
- Maximum negative output voltage swing
- Slew rate
- Quiescent power dissipation
- Input bias current
- Open-loop voltage amplification

- Unity-gain frequency
- Common-mode rejection ratio
- Phase margin
- DC output resistance
- AC output resistance
- Short-circuit output current limit







PSpice and Parts are trademarks of MicroSim Corporation.

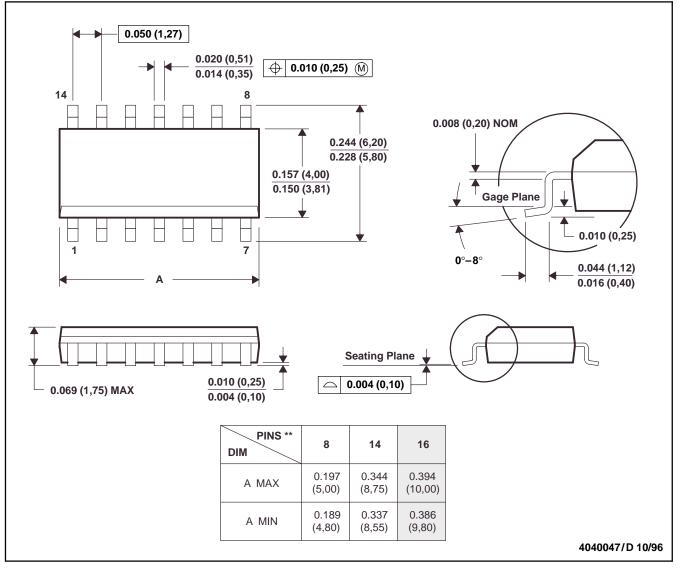


MECHANICAL DATA

D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PIN SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).



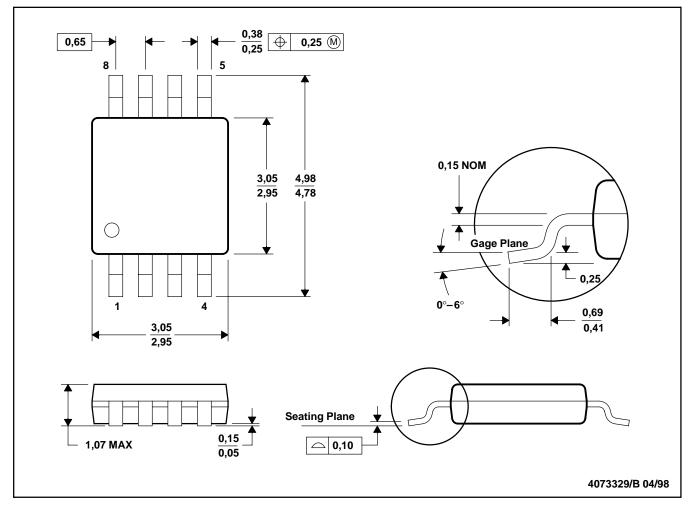
TLV2702 **TLV2704**

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MECHANICAL INFORMATION

DGK (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

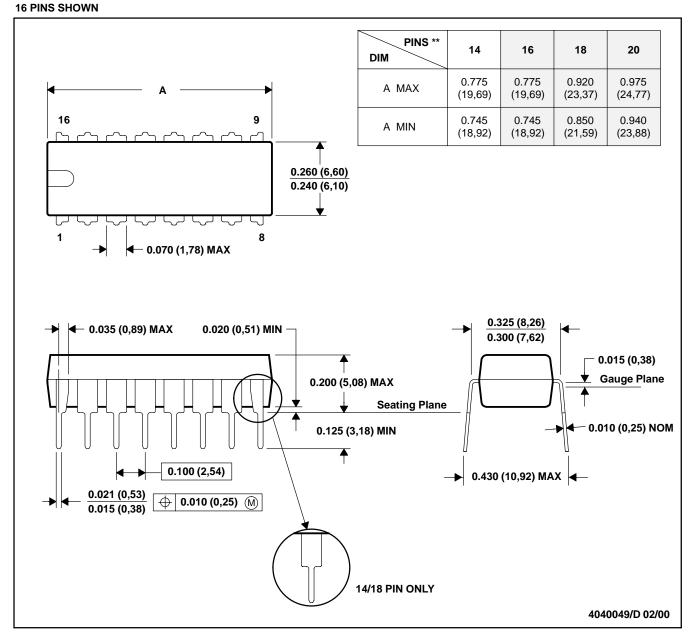
- B. This drawing is subject to change without notice.C. Body dimensions do not include mold flash or protrusion.
- D. Falls within JEDEC MO-187



MECHANICAL INFORMATION

PLASTIC DUAL-IN-LINE PACKAGE

N (R-PDIP-T**)



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Falls within JEDEC MS-001 (20-pin package is shorter than MS-001).



TLV2702 TLV2704

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PLASTIC DUAL-IN-LINE PACKAGE

MECHANICAL INFORMATION

0.400 (10,60) 0.355 (9,02) 5 8 0.260 (6,60) 0.240 (6,10) 0 ★. 1 4 0.070 (1,78) MAX 0.310 (7,87) 0.290 (7,37) 0.020 (0,51) MIN 0.200 (5,08) MAX Seating Plane 0.125 (3,18) MIN 0.100 (2,54) 0°-15° 0.021 (0,53) 0.015 (0,38) ⊕ 0.010 (0,25) M 0.010 (0,25) NOM 4040082/B 03/95

NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001

P (R-PDIP-T8)

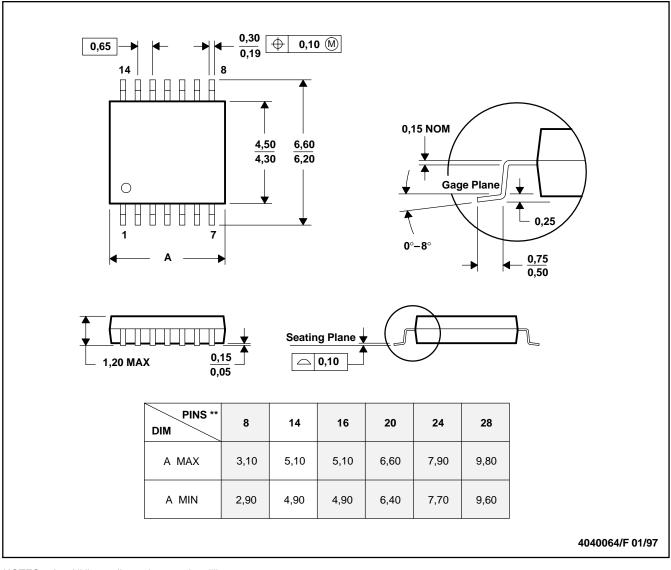


MECHANICAL INFORMATION

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153





PACKAGING INFORMATION

Orderable Device	Status	Package Type	•	Pins	•	Eco Plan	Lead finish/	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	Ball material	(3)		(4/5)	
							(6)				
TLV2702ID	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	27021	Samples
TLV2702IDG4	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	27021	Samples
TLV2702IDGK	ACTIVE	VSSOP	DGK	8	80	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	AQF	Samples
TLV2702IDGKG4	ACTIVE	VSSOP	DGK	8	80	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	AQF	Samples
TLV2702IP	ACTIVE	PDIP	Р	8	50	RoHS & Green	NIPDAU	N / A for Pkg Type	-40 to 125	TLV2702I	Samples
TLV2704ID	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	27041	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



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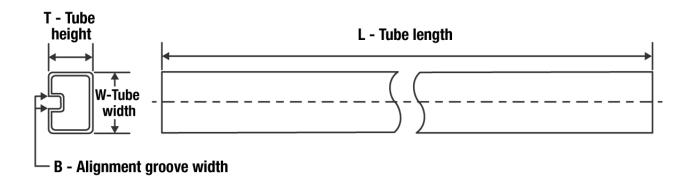
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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
TLV2702ID	D	SOIC	8	75	507	8	3940	4.32
TLV2702IDG4	D	SOIC	8	75	507	8	3940	4.32
TLV2702IP	Р	PDIP	8	50	506	13.97	11230	4.32
TLV2704ID	D	SOIC	14	50	507	8	3940	4.32

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